



Process / Product Change Notification

PCN No: 2013-006
Date: 10th October 2013
Subject: Re-introduction of CuMo base material for the MPLAD15KP and MPLAD30KP part families.

Description of Change:

This correspondence is official notification that from Date Code 1340 Microsemi will be re-introducing Copper-Molybdenum (CuMo) as an alternate material for the base plate of the devices listed below. Due to supply issues of the Ni Alloy base plate introduced on PCN 2012-007, the CuMo will ensure continuous supply of product to the customer. The base material will be identified in the Certificate of Conformance and will be also be traceable by date code.

The part specifications are available on the Microsemi website at www.microsemi.com.

Further technical information is available from your local Sales office or Félim Downey at (felim.downey@microsemi.com)

Open Orders:

All currently scheduled orders shall be delivered per the dates reflected in the Order Acknowledgement from Microsemi.

Part Numbers Affected:

All M/MA/MXL/MX level parts in the following Transient Voltage Suppressor series:

MPLAD15KP7.0A thru MPLAD15KP200CA, e3
MPLAD30KP14A thru MPLAD30KP400CA, e3

Date Code Implementation: 1340

Microsemi Contacts:

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